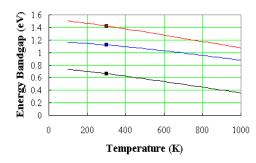


Temperature dependence of the energy bandgap

- The energy bandgap of semiconductors decreases as the temperature is increased.
- Can be understood in that the interatomic spacing increases when the amplitude of the atomic vibrations increases due to the increased thermal energy.
- An increased interatomic spacing decreases the potential seen by the electrons in the material, which in turn reduces the size of the energy gap bandgap.



Germanium Silicon GaAs Eg(0) [eV] 0.7437 1.166 1.519

$$E_{g}(T) = E_{g}(0) - \frac{\alpha T^{2}}{T + \beta}$$

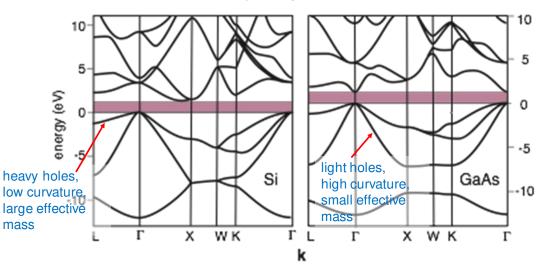
experimentally determined

This behaviour could also contribute to the increase in conductivity with temperature.

Heavy and light holes

Effective mass inversely proportional to the curvature of the band

$$m^*=\hbar^2\Big(\frac{d^2E(k)}{dk^2}\Big)^{-1}>0$$

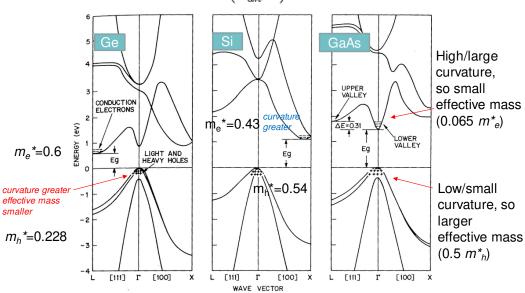


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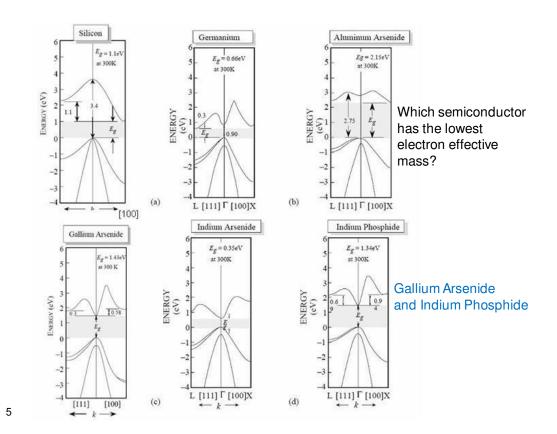
Heavy and light holes

Effective mass inversely proportional to the curvature of the band

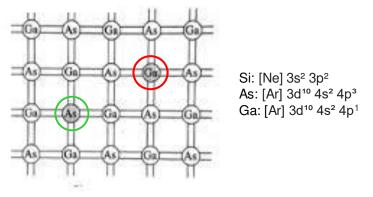
$$m^*=\hbar^2\Big(\frac{d^2E(k)}{dk^2}\Big)^{-1}>0$$



4



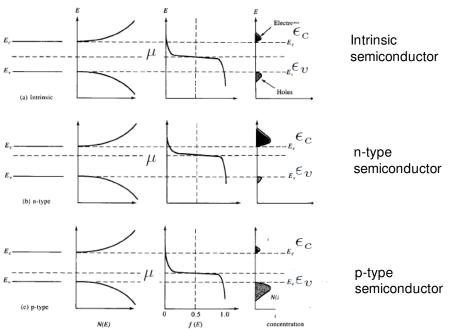
Question: n- and p-type doping Gallium Arsenide



If Si atoms are doped in the system and replace some Ga atoms, will Si-doped GaAs be n-type or p-type?

If the Si atoms replace instead As atoms, will GaAs be n- or p-type?

Band diagram, density of states, Fermi-Dirac distribution, and the carrier concentrations at thermal equilibrium



Note: degenerate semiconductor is a one with such a high level of doping that the material starts to act more like a metal than as a semiconductor.

Statistical mechanics of semiconductors

Recall from Lecture 2 – density of states for free electrons per unit volume:

$$g(\epsilon\geqslant 0)=\frac{(2m)^{3/2}}{2\pi^2\hbar^3}\sqrt{\epsilon}$$
 Electrons in conduction band like free electrons but with mass m*, can write:
$$g_c(\epsilon\geqslant \epsilon_c)=\frac{(2m_e^*)^{3/2}}{2\pi^2\hbar^3}\sqrt{\epsilon-\epsilon_c}$$
 E Similarly the density of states for holes near the top of the valence band are:
$$g_v(\epsilon\leqslant \epsilon_v)=\frac{(2m_h^*)^{3/2}}{2\pi^2\hbar^3}\sqrt{\epsilon_v-\epsilon}$$
 Valence Band

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The Fermi-Dirac distribution for a semiconductor

Recall:
$$n_F$$
 or $f(E) = \frac{1}{e^{(E-\mu)/k_BT}+1}$

It gives the probability that an available energy state E will be occupied by an electron at absolute temperature T.

- For a metal, the Fermi energy is the highest occupied energy at 0 K.
- For a semiconductor, the definition of the Fermi energy is not so clear. We use the chemical potential μ .
- Some also use the term "Fermi energy" for semiconductors, but then it is temperature-dependent.

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Statistical mechanics of semiconductors

For a given chemical potential, the total number of electrons in the conduction band as a function of temperature is:

$$n(T) = \int_{\epsilon_c}^{\infty} d\epsilon \, g_c(\epsilon) \, n_F(\beta(\epsilon - \mu)) = \int_{\epsilon_c}^{\infty} d\epsilon \, \frac{g_c(\epsilon)}{e^{\beta(\epsilon - \mu)} + 1}$$

where
$$\beta^{-1} = k_B T$$

If μ is well below the conduction band, i.e. if

(at room temp. $k_BT = 0.025 \text{ eV}$)

$$\beta(\epsilon - \mu) \gg 1$$

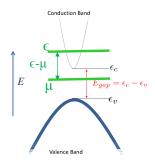
exponential very big; neglect the "1" in denominator

We have
$$\frac{1}{e^{\beta(\epsilon-\mu)}+1}\approx e^{-\beta(\epsilon-\mu)}$$
 Boltzman distribution replaces Fermi statistics

And then,

Boltzman distribution replaces Fermi statistics when T is low enough that that the density of electrons in the band is low

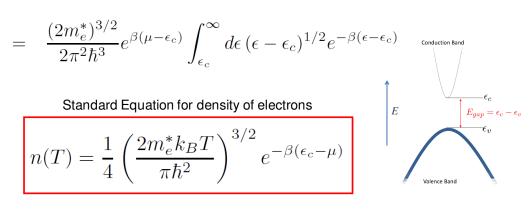
$$=\frac{(2m_e^*)^{3/2}}{2\pi^2\hbar^3}\int_{\epsilon_c}^{\infty}d\epsilon\,(\epsilon-\epsilon_c)^{1/2}e^{-\beta(\epsilon-\mu)} \tag{1}$$



Statistical mechanics of semiconductors

$$=\frac{(2m_e^*)^{3/2}}{2\pi^2\hbar^3}\int_{\epsilon_c}^{\infty}d\epsilon\,(\epsilon-\epsilon_c)^{1/2}e^{-\beta(\epsilon-\mu)}\quad \text{(1)}$$

Want to solve integral: multiply Eq. (1) by $e^{\beta(\mu-\epsilon_c)}$ $e^{\beta(\mu-\epsilon_c)}$ = 1



Electrons are activated from the chemical potential up into the conduction band

Working

Statistical mechanics of semiconductors

Similarly can get the number of holes p in the valence band as:

$$\begin{split} p(T) &= \int_{-\infty}^{\epsilon_v} d\epsilon \, g_v(\epsilon) \left[1 - \frac{1}{e^{\beta(\epsilon - \mu)} + 1} \right] & \text{ If the Fermi function } n_{\!\scriptscriptstyle F} \text{ gives the problemant } a \text{ state is occupied by an electron, the } 1 - n_{\!\scriptscriptstyle F} \text{ gives the prob. that the state is occupied by a hole.} \\ &= \int_{-\infty}^{\epsilon_v} d\epsilon \, \frac{g_v(\epsilon) e^{\beta(\epsilon - \mu)}}{e^{-\beta(\epsilon - \mu)} + 1} & \text{ Conduction Band } \\ & & \text{ Conduction Band } \end{split}$$

When μ substantially above the top of the valence band we have:

$$e^{\beta(\epsilon-\mu)} \ll 1$$

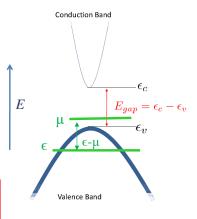
and

$$p(T) = \int_{-\infty}^{\epsilon_v} d\epsilon \, g_v(\epsilon) e^{\beta(\epsilon - \mu)}$$

Standard Equation for density of holes

$$p(T) = \frac{1}{4} \left(\frac{2m_h^* k_B T}{\pi \hbar^2} \right)^{3/2} e^{-\beta(\mu - \epsilon_v)}$$

If the Fermi function n_F gives the prob. a state is occupied by an electron, then



Holes are activated from the chemical potential down into the valence band

Law of Mass Action

Forming product of density of electrons in conduction band and holes in the valence band we obtain important relation:

$$n(T)p(T) = \frac{1}{2} \left(\frac{k_B T}{\pi \hbar^2}\right)^3 (m_e^* m_h^*)^{3/2} e^{-\beta(\epsilon_c - \epsilon_v)}$$
$$= \frac{1}{2} \left(\frac{k_B T}{\pi \hbar^2}\right)^3 (m_e^* m_h^*)^{3/2} e^{-\beta E_{gap}}$$

Depends on band gap $E_{gap} = \epsilon_c - \epsilon_v$

Intrinsic semiconductors

Number of electrons excited into conduction band must equal number of holes left behind in valence band so p = n.

Dividing the density of electrons in conduction band n(T), and holes in the valence band p(T) we obtain:

$$1 = \left(\frac{m_e^*}{m_h^*}\right)^{3/2} e^{-\beta(\epsilon_v + \epsilon_c - 2\mu)}$$

Intrinsic semiconductors

Taking the log of both sides of the below

$$1 = \left(\frac{m_e^*}{m_h^*}\right)^{3/2} e^{-\beta(\epsilon_v + \epsilon_c - 2\mu)}$$

and solving for μ gives:

$$\mu = \frac{1}{2}(\epsilon_c + \epsilon_v) + \frac{3}{4}(k_B T)\log(m_h^*/m_e^*)$$

This is an expression for the chemical potential – at T=0 gives it exactly in the **middle of the band-gap**.

Using the law of Mass Action above with n=p we obtain:

$$n_{intrinsic} = p_{intrinsic} = \sqrt{np} = \frac{1}{\sqrt{2}} \left(\frac{k_B T}{\pi \hbar^2}\right)^{3/2} (m_e^* m_h^*)^{3/4} e^{-\beta E_{gap}/2}$$

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Extrinsic/doped semiconductors

Law of Mass Action also holds for doping when we have concentrations n and p.

(see Oxford Basics p. 193 for details)

Consider intrinsic case:

$$I = n_{intrinsic} = p_{intrinsic}$$

From the law of mass action we have product of electron and hole concentrations, equals square of intrinsic concentration.

$$np = I^2 = \frac{1}{2} \left(\frac{k_B T}{\pi \hbar^2} \right)^3 (m_e^* m_h^*)^{3/2} e^{-\beta E_{gap}}$$

Example

Using prefactor
$$N_{\mathrm{eff}}^C=10^{25}\mathrm{m}^{-3}$$

$$n_{intrinsic} = p_{intrinsic} = \sqrt{np} = \frac{1}{\sqrt{2}} \left(\frac{k_B T}{\pi \hbar^2}\right)^{3/2} \left(m_e^* m_h^*\right)^{3/4} e^{-\beta E_{gap}/2}$$

	gap size (eV)	<i>n</i> in m ⁻³ at 150 K	<i>n</i> in m ⁻³ at 300 K
InSb	0.18	2x10 ²²	6x10 ²³
Si	1.11	4x10 ⁶	2x10 ¹⁶
diamond	5.5	6x10 ⁻⁶⁸	1x10 ⁻²¹

Remember: metal is about 10²⁸ per m³

InSb: high and fairly constant. Si: strongly T-dep; from almost nothing to

something relevant. Diamond: dramatic but irrelevant

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Example question

Consider a Si sample at T = 300 K, doped with Boron to a concentration 2×10^{16} cm⁻³.

Given the intrinsic concentration $n_i = p_i$ is 1×10^{10} cm⁻³, what are the electron and hole concentrations (n and p) in this sample? Is it n-type or p-type?

Example question

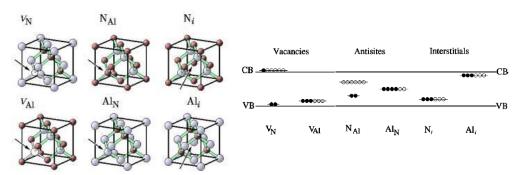
Suppose the sample is doped additionally with phosphorus to a concentration $6\times10^{16}\,\text{cm}^{-3}$.

Is the material now n-type or p-type? What are the n and p concentrations now?

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Native defects in AIN: example

Electronic structure calculations



Give rise to various states in the band gap

Consider typical native (intrinsic) defects

But how likely are these defects to form?

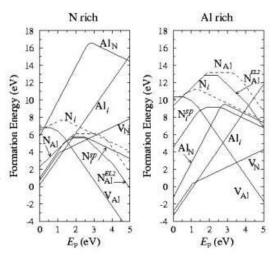
Native defects in AIN

Can calculate formation energies

$$E^f(q) = E_{\text{defect}}^{\text{tot}}(q) - E_{\text{tot}}^{\text{tot}}(\text{bulk}) - n_{\text{Al}}\mu_{\text{Al}} - n_{\text{N}}\mu_{\text{N}} + qE_F$$

as function of position of chemical potential (of "Fermi level").

 V_N has the lowest formation energy in p-type material (near E_F = 0, i.e. near the valence band maximum) and the aluminium vacancy, V_{Al} , has the lowest formation energy in n-type material (near E_F = 5, i.e. closer to the conduction band minimum).

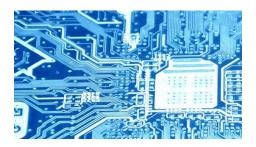


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Semiconductor devices

The development of semiconductor electronic devices constitutes perhaps the greatest technological advance of the modern era.



This entire industry owes its very existence to our detailed understanding of quantum condensed matter physics.

Invention of the transistor was due to the Bell Labs (famous labs located near New York) team of J. Bardeen, W. Brattain, and W. Shockley in 1947. Received the Nobel Prize for this. Perhaps the most important invention of the 20th century.

Bardeen left Bell Labs to the University of Illinois, Champagne-Urbana, where he started work on the theory of superconductivity, for which he won a **second** Nobel Prize (BSC theory).

Every iPad, iPhone contains billions of transistors

Drain

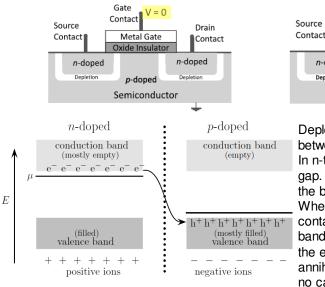
n-doped

Contact

n-MOSFET transistor

acts as a switch or amplifier

Usually a combination of n- and p-type MOSFETS are on the same chip – called "complementary MOS logic" - CMOS



Depletion layer is region formed between n- and p-type material. In n-type μ is near the top of the bandgap. In p-type μ is near the bottom of the band-gap.

Gate

Contact

Metal Gate

Oxide Insulator

p-doped

Semiconductor

When the two materials are brought into contact, electrons in the conduction band fall into the valence band, filling the empty hole states and pairannihilating creating a region with no carriers.

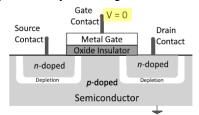
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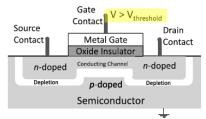
n-MOSFET transistor

Oxford Basics, Ch. 18

acts as a switch or amplifier

Usually a combination of n- and p-type MOSFETS are on the same chip-called "complementary MOS logic" - CMOS





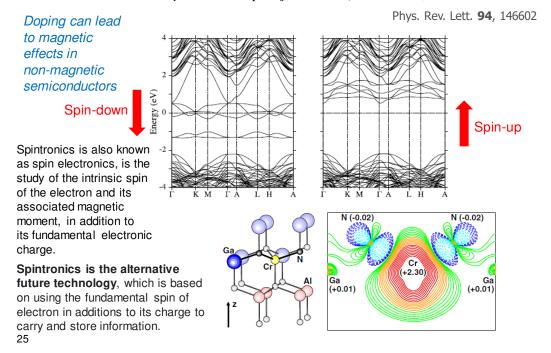
When a positive voltage is applied to the metal gate, it attracts negative charge to the region just under the oxide insulator. This attraction of charge is known as a "field effect", since it is the result of an electric field caused by the gate.

If the gate voltage larger than some particular threshold voltage the region under the gate becomes effectively n-like. Then there is a continuous channel of n-semiconductor that stretches from the source to the drain and the conductance between source and drain becomes very large.

Thus, a small voltage on the gate can control a large current between the source and drain, hence providing amplification of small signals.

Semiconductors for spintronics

 $Half-Metallicity\ and\ Efficient\ Spin\ Injection\ in\ AlN/GaN: Cr\ (0001)\ Heterostructure$



End